

## GENERAL DESCRIPTION

KYOCERA AVX's 800 C Series offers superb performance in demanding high RF power applications requiring consistent and reliable operation. The combination of highly conductive metal electrode systems, optimized case geometries, and proprietary dielectrics, yields the lowest ESR. KYOCERA AVX's new NPO low loss rugged dielectrics are designed to provide superior heat transfer in high RF power applications. Ultra-low ESR and superior thermal performance ensure that the 800C Series products are your best choice for high RF power applications from VHF through microwave frequencies.

## TYPICAL APPLICATIONS

- Bypass
- DC Blocking
- Coupling
- Impedance Matching
- Tuning

## TYPICAL CIRCUIT APPLICATIONS

- HF/RF Power Amplifiers
- Plasma Chambers
- Transmitters
- Medical (MRI coils)
- Antenna Tuning

## ENVIRONMENTAL TEST

Thermal Shock	MIL-STD-202, Method 107, Condition A.
Moisture Resistance	MIL-STD-202, Method 106.
Low Voltage Humidity	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours min.
Life Test	MIL-STD-202, Method 108, for 2000 hours, at 125°C. Voltage applied. 200% of WVDC for capacitors rated at 500 volts DC or less. 120% of WVDC for capacitors rated at 1250 volts DC or less. 100% of WVDC for capacitors rated above 1250 volts DC.

## FEATURES

- Case C Size (.250" x .250")
- High Q
- Low ESR/ESL
- High RF Power
- 3600 WVDC
- Capacitance Range: 2.2 pF to 3000 pF
- Ultra-Stable Performance
- High RF Current/Voltage
- High Reliability
- RoHS Compliant, Pb free

## PACKAGING OPTIONS



Tape &amp; Reel



Tray (180 pcs)



## ENVIRONMENTAL CHARACTERISTICS

Quality Factor (Q)	Greater than 2,000 at 1 MHz (Cap Values <=10pf .0010 Max. @ 1MHz Cap Values >10pf .0005 Max. @ 1MHz)
Temperature Coefficient of Capacitance (TCC)	0 ±30 PPM/°C (-55°C to +125°C)
Insulation Resistance (IR)	2.2 pF to 3000 pF: 10 <sup>5</sup> Megohms min. @ +25°C at rated WVDC. 10 <sup>4</sup> Megohms min. @ +125°C at rated WVDC. Max. test voltage is 500 VDC.
Working Voltage (WVDC)	See Capacitance Values Table
Dielectric Withstanding Voltage (DWV)	250% of WVDC for capacitors rated at 500 volts DC or less for 5 seconds. 150% of WVDC for capacitors rated above 500 volts DC and ≤1250 volts DC for 5 seconds. 120% of WVDC for capacitors rated above 1250 volts DC for 5 seconds.
Retrace	Less than ±(0.02% or 0.02 pF), whichever is greater.
Aging Effects	None
Piezoelectric Effects	None
Capacitance Drift	±(0.02% or 0.02 pF), whichever is greater.
Operating Temperature Range	From -55°C to +125°C (No derating of working voltage).
Termination Styles	See Mechanical Configurations
Terminal Strength	Terminations for chips withstand a pull of 10 lbs. min., 20 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor. Test per MIL-STD-202, method 211.

# RF/Microwave Capacitors

## RF/Microwave Multilayer Capacitors (MLC)

### 800C Series NP0 Porcelain, High RF Power Ultra-Low ESR



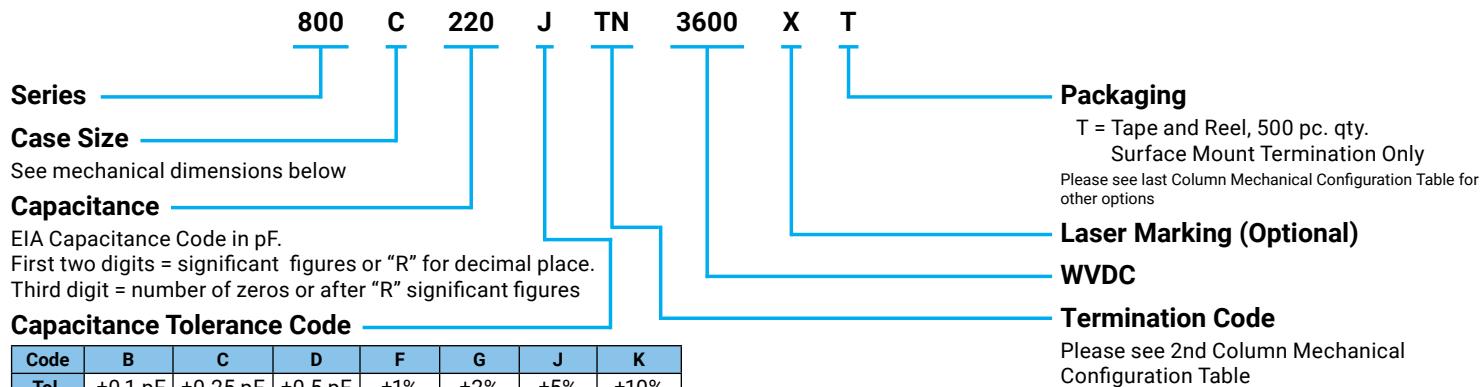
#### CAPACITANCE VALUES

CAP CODE	CAP (pF)	TOL.	RATED WVDC	CAP CODE	CAP (pF)	TOL.	RATED WVDC	CAP CODE	CAP (pF)	TOL.	RATED WVDC
2R2	2.2	B, C, D	3600	240	24	F, G, J, K	2500	241	240	F, G, J, K	1000
2R4	2.4			270	27			271	270		
2R7	2.7			300	30			301	300		
3R0	3.0			330	33			331	330		
3R3	3.3			360	36			361	360		
3R6	3.6			390	39			391	390		
3R9	3.9			430	43			431	430		
4R3	4.3			470	47			471	470		
4R7	4.7			510	51			511	510		
5R1	5.1			560	56			561	560		
5R6	5.6			620	62			621	620		
6R2	6.2			680	68			681	680		
6R8	6.8			750	75			751	750		
7R5	7.5			820	82			821	820		
8R2	8.2			910	91			911	910		
9R1	9.1			101	100			102	1000		
100	10	F, G, J, K	3600	111	110			112	1100		
110	11			121	120			122	1200		
120	12			131	130			152	1500		
130	13			151	150			182	1800		
150	15			161	160			222	2200		
160	16			181	180			242	2400		
180	18			201	200			272	2700		
200	20			221	220			302	3000		
220	22										

VRMS = 0.707 X WVDC

• SPECIAL VALUES, TOLERANCES AND MATCHING AVAILABLE. PLEASE CONSULT FACTORY.

#### HOW TO ORDER



The above part number refers to a 800 C Series (case size C) 22 pF capacitor, J tolerance (±5%),3600 WVDC, with TN termination (RoHS Compliant, Tin Plated over Non-Magnetic Barrier Termination), laser marking and T&R packaging.



The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at [www.kyocera-avx.com/disclaimer/](http://www.kyocera-avx.com/disclaimer/) by reference and should be reviewed in full before placing any order.

# RF/Microwave Capacitors

## RF/Microwave Multilayer Capacitors (MLC)

### 800C Series NP0 Porcelain, High RF Power Ultra-Low ESR



## MECHANICAL CONFIGURATIONS

Series & Case Size	Term. Code	Case Size & Type	Outlines W/T Is A Termination Surface	Body Dimensions Inches (mm)			Lead And Termination Dimensions And Materials			
				Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials	Pkg Type	Pkg Code
800C	T	 Solderable Barrier	 $Y \rightarrow     \leftarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $W$ $\downarrow$	230+.025-.010 (5.84+.064-.025)				RoHS Compliant Tin Plated over Nickel Barrier Termination	T&R, 250 or 500 pcs Tray, 36 or 180 pcs	T250 or T J36 or J180
800C	MS	 Microstrip	 $W_L$ $\downarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $L_L$ $T_L$ $W$ $\downarrow$		250 ±.015 (6.35 ±0.38)	.200 (5.08) max.	.040 (1.02) max.	High Purity Silver Leads $L_L = .500$ (12.7) min. $W_L = .240 \pm .005$ (6.10 ±.127) $T_L = .004 \pm .001$ (.102 ±.025) Leads are Attached with High Temperature Solder	Tray, 24 or 60 pcs	J24 or J60
800C	AR	 Axial Ribbon	 $W_L$ $\downarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $L_L$ $T_L$ $W$ $\downarrow$	245 ±.025 (6.22 ±0.64)				Silver Leads $L_L = .500$ (12.7) min. $W_L = **$ See below $T_L = .004 \pm .001$ (.102 ±.025)	Box, 24 pcs	B24

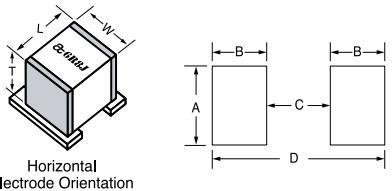
Custom lead styles and lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are RoHS compliant.

\*\*  $W_L = .110$  (2.79) for capacitance values  $\leq 680$  pF;  $W_L = .130$  (3.30) for capacitance values  $> 680$  pF

## NON-MAGNETIC MECHANICAL CONFIGURATIONS

Series & Case Size	Term. Code	Case Size & Type	Outlines W/T Is a Termination Surface	Body Dimensions Inches (mm)			Lead and Termination Dimensions and Materials			
				Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials	Pkg Type	Pkg Code
800C	TN	 C Non-Mag Solderable Barrier.	 $Y \rightarrow     \leftarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $W$ $\downarrow$	230+.025-.010 (5.84+.064-.025)				RoHS Compliant Tin Plated over Non-Magnetic Barrier Termination	T&R, 250 or 500 pcs Tray, 36 or 180 pcs	T250 or T J36 or J180
800C	MN	 Non-Mag Microstrip245	 $W_L$ $\downarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $L_L$ $T_L$ $W$ $\downarrow$	±.025 (6.22 ±0.64)	50 ±.015 (6.35 ±0.38)	.200 (5.08) max.	.040 (1.02) max.	High Purity Silver Leads $L_L = .500$ (12.7) min. $W_L = .240 \pm .005$ (6.10 ±.127) $T_L = .004 \pm .001$ (.102 ±.025) Leads are Attached with High Temperature Solder	Tray, 24 or 60 pcs	J24 or J60
800C	AN	 Non-Mag Axial Ribbon	 $W_L$ $\downarrow$ $\rightarrow   L   \leftarrow   T   \leftarrow$ $L_L$ $T_L$ $W$ $\downarrow$	245 ±.025 (6.22 ±0.64)				Silver Leads $L_L = .500$ (12.7) min. $W_L = **$ See below $T_L = .004 \pm .001$ (.102 ±.025)	Tray, 24 or 60 pcs	J24 or J60

## SUGGESTED MOUNTING PAD DIMENSIONS



Case C Horizontal Mount					
Cap Value	Pad Size	A Min.	B Min.	C Min.	D Min.
All Values	Normal	.280	.050	.200	.300
	High Density	.260	.030	.200	.260

Dimensions are in inches.

## PERFORMANCE DATA

